

TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC74LCX374F, TC74LCX374FW, TC74LCX374FT**LOW VOLTAGE OCTAL D-TYPE FLIP-FLOP
WITH 5V TOLERANT INPUTS AND OUTPUTS**

The TC74LCX374 is a high performance CMOS OCTAL D-TYPE FLIP FLOP. Designed for use in 3.3 Volt systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

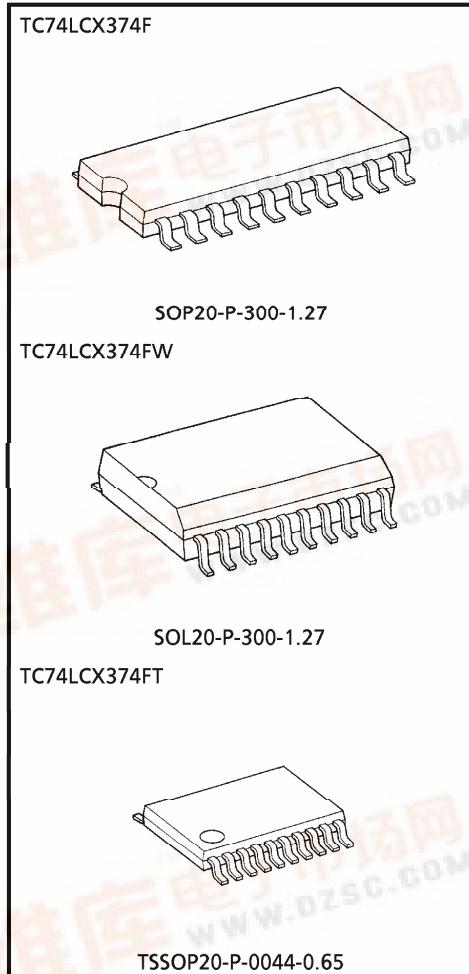
The device is designed for low-voltage (3.3V) V_{CC} applications, but it could be used to interface to 5V supply environment for both inputs and outputs.

This 8bit D-type flip-flop is controlled by a clock input (CK) and a output enable input (\overline{OE}). When the \overline{OE} input is high, the eight outputs are in a high impedance state. All inputs are equipped with protection circuits against static discharge.

FEATURES

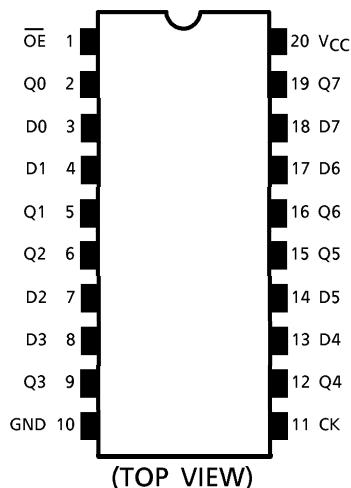
- Low voltage operation : $V_{CC} = 2.0 \sim 3.6V$
- High speed operation : $t_{pd} = 8.5\text{ns}$ (Max.)
($V_{CC} = 3.0 \sim 3.6V$)
- Output current : $|I_{OH}| / |I_{OL}| = 24\text{mA}$ (Min.)
($V_{CC} = 3.0V$)
- Latch-up performance : $\pm 500\text{mA}$
- Available in JEDEC SOP, EIAJ SOP and TSSOP
- Power down protection is provided on all inputs and outputs.
- Pin and function compatible with the 74 series (74AC / VHC / HC / F / ALS / LS etc.) 374 type.

(Note) The JEDEC SOP (FW) is not available in Japan.

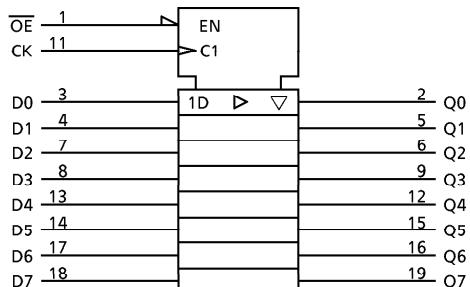
**Weight**

SOP20-P-300-1.27	: 0.22g (Typ.)
SOL20-P-300-1.27	: 0.46g (Typ.)
TSSOP20-P-0044-0.65	: 0.08g (Typ.)

PIN ASSIGNMENT



IEC LOGIC SYMBOL



TRUTH TABLE

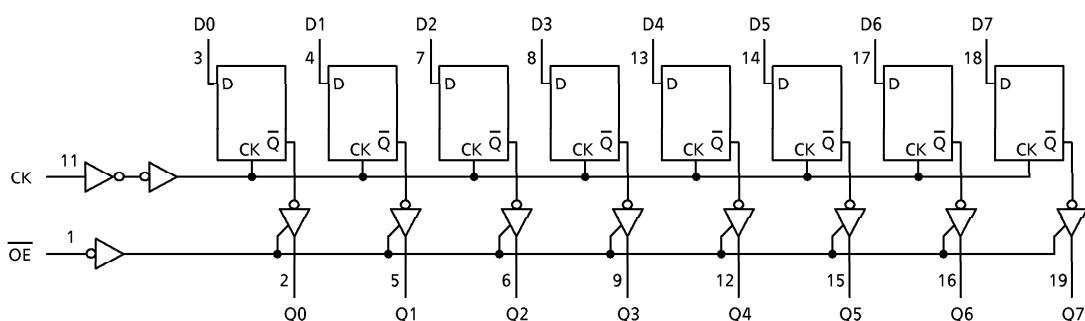
INPUTS			OUTPUTS
\overline{OE}	CK	D	Z
H	X	X	Z
L	—	X	Q_n
L	—	L	L
L	—	H	H

X : Don't Care

Z : High Impedance

 Q_n : No change

SYSTEM DIAGRAM



961001EBA2'

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- The information contained herein is subject to change without notice.

MAXIMUM RATINGS

PARAMETER	SYMBOL	RATING	UNIT
Supply Voltage Range	V_{CC}	-0.5~7.0	V
DC Input Voltage	V_{IN}	-0.5~7.0	V
DC Output Voltage	V_{OUT}	-0.5~7.0 (Note 1)	V
		-0.5~ V_{CC} + 0.5 (Note 2)	
Input Diode Current	I_{IK}	-50	mA
Output Diode Current	I_{OK}	± 50 (Note 3)	mA
DC Output Current	I_{OUT}	± 50	mA
Power Dissipation	P_D	180	mW
DC V_{CC} /Ground Current	I_{CC}/I_{GND}	± 100	mA
Storage Temperature	T_{stg}	-65~150	°C

(Note 1) Output in Off-State

(Note 2) High or Low State. I_{OUT} absolute maximum rating must be observed.(Note 3) $V_{OUT} < GND$, $V_{OUT} > V_{CC}$

RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	RATING	UNIT
Supply Voltage	V_{CC}	2.0~3.6	V
		1.5~3.6 (Note 4)	
Input Voltage	V_{IN}	0~5.5	V
Output Voltage	V_{OUT}	0~5.5 (Note 5)	V
		0~ V_{CC} (Note 6)	
Output Current	I_{OH}/I_{OL}	± 24 (Note 7)	mA
		± 12 (Note 8)	
Operating Temperature	T_{opr}	-40~85	°C
Input Rise And Fall Time	dt/dv	0~10 (Note 9)	ns/V

(Note 4) Data Retention Only

(Note 5) Output in Off-State

(Note 6) High or Low State

(Note 7) $V_{CC} = 3.0 \sim 3.6V$ (Note 8) $V_{CC} = 2.7 \sim 3.0V$ (Note 9) $V_{IN} = 0.8 \sim 2.0V$, $V_{CC} = 3.0V$

ELECTRICAL CHARACTERISTICSDC characteristics ($T_a = -40\sim85^\circ C$)

PARAMETER		SYMBOL	TEST CONDITION		V_{CC} (V)	MIN.	MAX.	UNIT	
Input Voltage	"H" Level	V_{IH}			2.7~3.6	2.0	—	V	
	"L" Level	V_{IL}			2.7~3.6	—	0.8		
Output Voltage	"H" Level	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -100\mu A$	2.7~3.6	$V_{CC} - 0.2$	—	V	
				$I_{OH} = -12mA$	2.7	2.2	—		
				$I_{OH} = -18mA$	3.0	2.4	—		
				$I_{OH} = -24mA$	3.0	2.2	—		
	"L" Level	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 100\mu A$	2.7~3.6	—	0.2		
				$I_{OL} = 12mA$	2.7	—	0.4		
				$I_{OL} = 16mA$	3.0	—	0.4		
				$I_{OL} = 24mA$	3.0	—	0.55		
Input Leakage Current	I_{IN}	$V_{IN} = 0\sim 5.5V$		2.7~3.6	—	± 5.0	μA		
3-State Output Off-State Current	I_{OZ}	$V_{IN} = V_{IH}$ or V_{IL}		2.7~3.6	—	± 5.0	μA		
Power Off Leakage Current	I_{OFF}	$V_{IN} / V_{OUT} = 5.5V$		0	—	10.0	μA		
Quiescent Supply Current	I_{CC}	$V_{IN} = V_{CC}$ or GND		2.7~3.6	—	10.0	μA		
		$V_{IN} / V_{OUT} = 3.6\sim 5.5V$		2.7~3.6	—	± 10.0			
Increase In I_{CC} Per Input	ΔI_{CC}	$V_{IH} = V_{CC} - 0.6V$		2.7~3.6	—	500	μA		

AC characteristics ($T_a = -40\sim85^\circ C$)

PARAMETER	SYMBOL	TEST CONDITION	V_{CC} (V)	MIN.	MAX.	UNIT
Maximum Clock Frequency	f_{MAX}	(Fig.1, 2)	2.7	—	—	MHz
			3.3 ± 0.3	150	—	
Propagation Delay Time (CK-Q)	t_{pLH} t_{pHL}	(Fig.1, 2)	2.7	—	9.5	ns
			3.3 ± 0.3	1.5	8.5	
Output Enable Time	t_{pZL} t_{pZH}	(Fig.1, 3)	2.7	—	9.5	ns
			3.3 ± 0.3	1.5	8.5	
Output Disable Time	t_{pLZ} t_{pHZ}	(Fig.1, 3)	2.7	—	8.5	ns
			3.3 ± 0.3	1.5	7.5	
Minimum Pulse Width (CK)	t_w (H) t_w (L)	(Fig.1, 2)	2.7	4.0	—	ns
			3.3 ± 0.3	3.3	—	
Minimum Set-Up Time	t_s	(Fig.1, 2)	2.7	2.5	—	ns
			3.3 ± 0.3	2.5	—	
Minimum Hold Time	t_h	(Fig.1, 2)	2.7	1.5	—	ns
			3.3 ± 0.3	1.5	—	
Output To Output Skew	t_{osLH} t_{osHL}	(Note 10)	2.7	—	—	ns
			3.3 ± 0.3	—	1.0	

(Note 10) Parameter guaranteed by design.

$$(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLM} - t_{pHLn}|)$$

DYNAMIC SWITCHING CHARACTERISTICS ($T_a = 25^\circ C$, Input $t_r = t_f = 2.5\text{ns}$, $C_L = 50\text{pF}$, $R_L = 500\Omega$)

PARAMETER	SYMBOL	TEST CONDITION	V_{CC} (V)	TYP.	UNIT
Quiet Output Maximum Dynamic V_{OL}	V_{OLP}	$V_{IH} = 3.3\text{V}$, $V_{IL} = 0\text{V}$	3.3	0.8	V
Quiet Output Minimum Dynamic V_{OL}	$ V_{OLV} $	$V_{IH} = 3.3\text{V}$, $V_{IL} = 0\text{V}$	3.3	0.8	V

CAPACITIVE CHARACTERISTICS ($T_a = 25^\circ C$)

PARAMETER	SYMBOL	TEST CONDITION	V_{CC} (V)	TYP.	UNIT
Input Capacitance	C_{IN}	—	3.3	7	pF
			3.3	8	pF
Output Capacitance	C_{OUT}	(Note 11)	3.3	25	pF
Power Dissipation Capacitance	C_{PD}	$f_{IN} = 10\text{MHz}$	3.3	25	pF

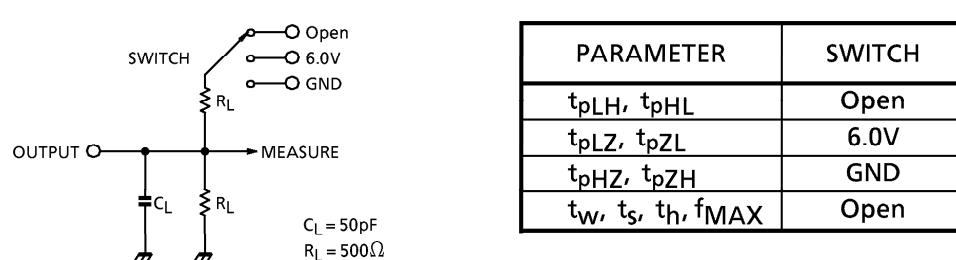
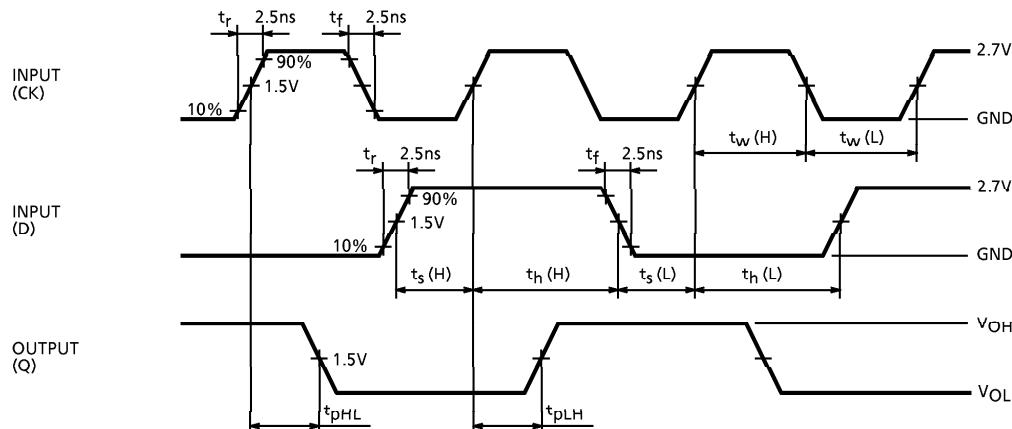
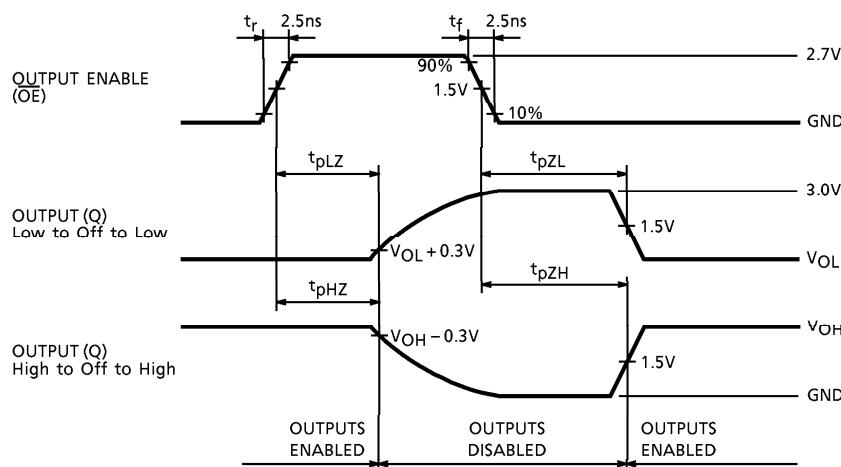
(Note 11) C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation :

$$I_{CC}(\text{opr.}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

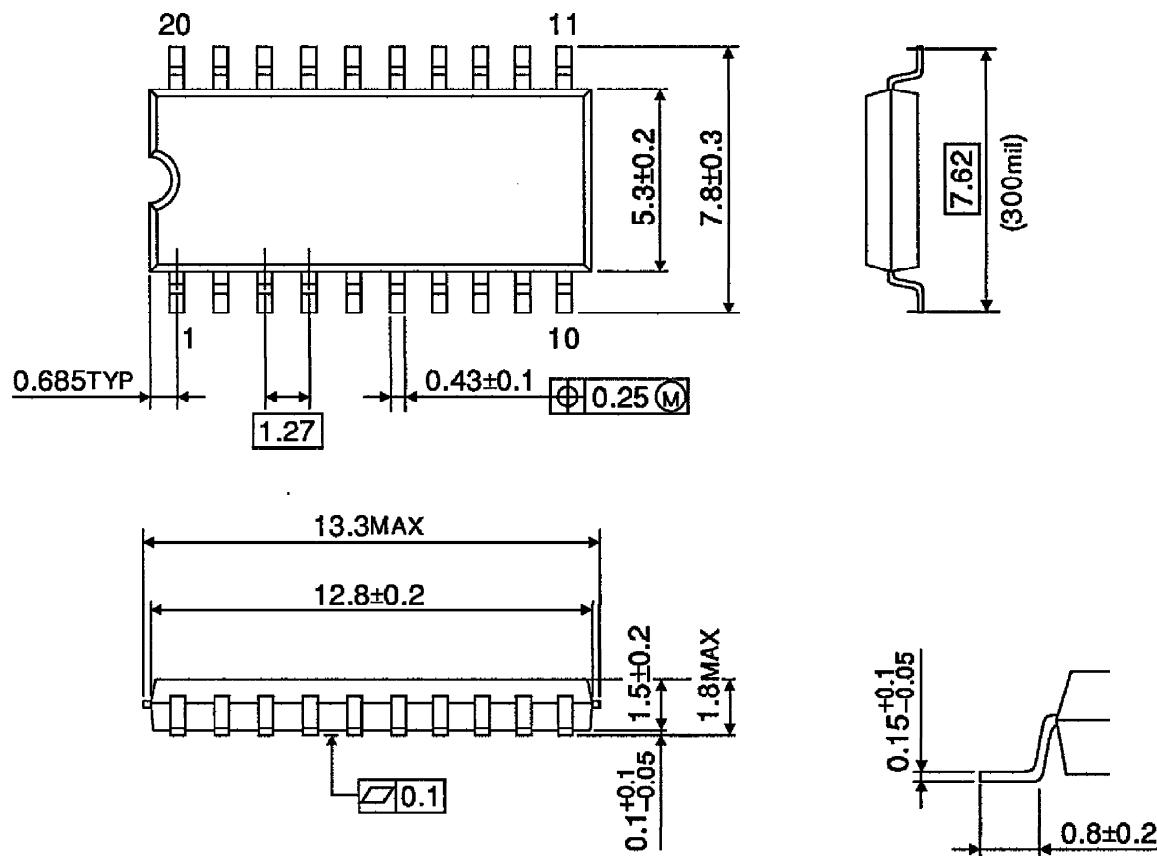
TEST CIRCUIT

Fig.1

**AC WAVEFORM**Fig.2 $t_{pLH}, t_{pHL}, t_w, t_s, t_h$ Fig.3 $t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}$ 

OUTLINE DRAWING
SOP20-P-300-1.27

Unit : mm



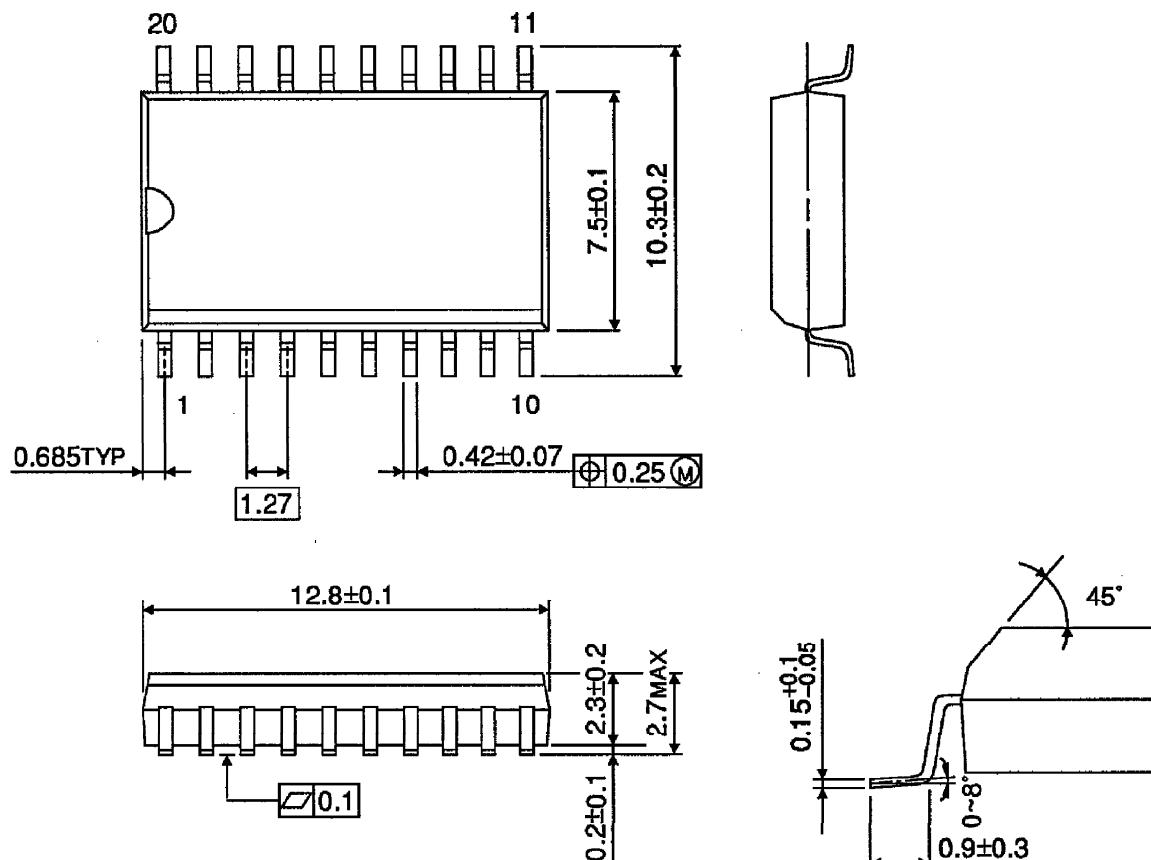
Weight : 0.22g (Typ.)

OUTLINE DRAWING

SOL20-P-300-1.27

Unit : mm

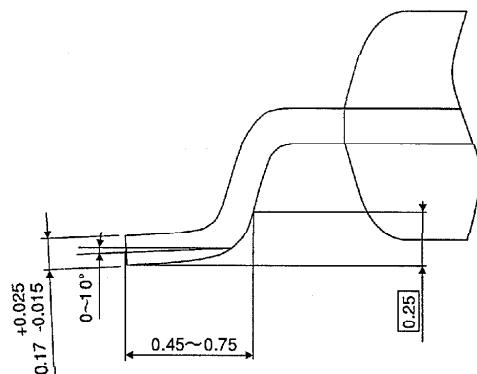
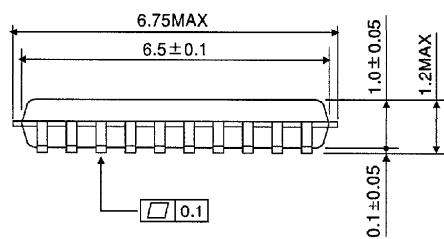
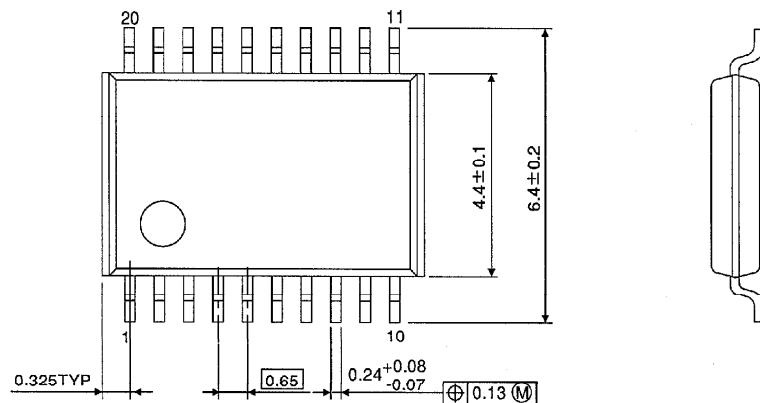
(Note) This package is not available in Japan.



Weight : 0.46g (Typ.)

OUTLINE DRAWING
TSSOP20-P-0044-0.65

Unit : mm



Weight : 0.08g (Typ.)